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Substitute for form 1449A/PTO				Complete if Known			
- Cui	201000101101111111111111111111111111111			Application Number	10/781,672-Conf. #5550		
11	NFORMATION	N DI	SCLOSURE	Filing Date	February 20, 2004		
S	TATEMENT	BY.	APPLICANT	First Named Inventor	Tsuyoshi ITAYA		
				Art Unit	2622		
	(Use as many sh	eets a	s necessary)	Examiner Name	M. Lee		
Sheet	1	of	1	Attorney Docket Number	1248-0701P		

U.S. PATENT DOCUMENTS					
Examiner Initials*	Cite No.1	Document Number Number-Kind Code ² (if known)	Publication Date MM-DD-YYYY	Name of Patentee or Applicant of Cited Document	Pages, Columns, Lines, Where Relevant Passages or Relevant Figures Appear
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Examiner	Date
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*EXAMINER: Initial if reference considered, whether or not classion is in conformance with MPEP 900. Draw line through classion if not in conformance and not considered, include copy of this form with next communication to applicant. "OTE NO: Those application(s) which are marked with an shiple saterial () next to the Class No. are explored (under 50°CFT 1.986q/C/g/ling linessee that application was filed after burney above 20°CFT 1.986q/C/g/ling linessee that application was filed after burney above 20°CFT 1.986q/C/g/ling linessee that application was filed after burney above 20°CFT 1.986q/C/g/ling linessee that application was filed after burney above 20°CFT 1.986q/C/g/ling linessee that application was filed after burney above 20°CFT 1.986q/C/g/linessee 1.986q/C/g/g/linessee 1.986q/C/g/liness